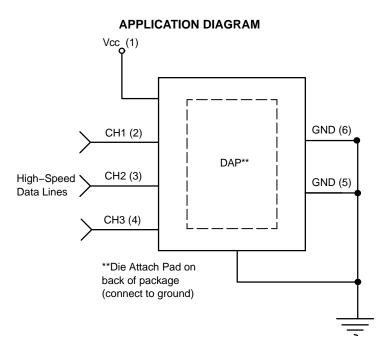
4-Channel Low Capacitance Dual-Voltage ESD and Surge Protection Array

Features

- 3 Channels of Low Voltage ESD Protection
- 1 Channel of High Voltage ESD Protection
- Provides ESD Protection to IEC61000-4-2 Level 4: ±25 kV Contact Discharge
- IEC 61000–4–5 (lighting)
- Low Channel Input Capacitance
- High Voltage Zener Diode Protects Supply Rail up to 100 A (8/20 µs)
- These Devices are Pb–Free and are RoHS Compliant





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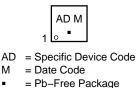
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UDFN-6 D4 SUFFIX CASE 517CS

BLOCK DIAGRAM

MARKING DIAGRAM



ORDERING INFORMATION

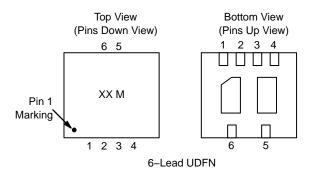
Device	Package	Shipping [†]
ESD7124MUTBG	UDFN–6 (Pb–Free)	3000/Tape & Reel
	(FD-Flee)	Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Table 1. PIN DESCRIPTIONS

	4–Channel, 6–Lead, UDFN–8 Package					
Pin	Pin Name Type Description					
1	V _{CC}	$\rm HV V_{\rm DD}$	HV ESD Channel			
2	CH1	I/O	LV Low-capacitance ESD Channel			
3	CH2	I/O	LV Low-capacitance ESD Channel			
4	СНЗ	I/O	LV Low-capacitance ESD Channel			
5	GND		Ground			
6	GND		Ground			

PACKAGE / PINOUT DIAGRAMS



SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Operating Temperature Range	-55 to +125	°C
Storage Temperature Range	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. ELECTRICAL CHARACTERISTICS

	Reverse Working Voltage	g Breakdown Voltage Vbr (V) at 1 mA		Reverse Current Leakage Ir (µA)	Rdyn	Junction Capactance Cj(pF)	
	Vrwm (V)			t 1 mA at Vrwm		Vr = 0 V, f = 1 MHz	
Device Name	Max	Min	Тур	Max	Тур	Тур	Max
Pin2-4 (LV)	3.3	5.5 6.5		1	1	0.35	0.5
Pin1 (HV)	12	13.3	14	1			

		′oltage Vc (V) x 20 μs		Ratings 8 x 20 μs	
	lpp = 1 A	lpp = 16 A	lpp (A)	Vc @ Max lpp (V)	
Device Name	Тур	Тур	Max	Мах	
Pin1 (HV)	15	16	100	27	
Pin2-4 (LV)	9.5				

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Clamping Voltage TLP (Note 1) All Devices Pin2-4(LV) See Figures 3 – 6	V _C	$I_{PP} = \pm 8 \text{ A} \qquad \begin{cases} IEC 61000-4-2 \text{ Level 2 equivalent} \\ (\pm 4 \text{ kV Contact}, \pm 4 \text{ kV Air}) \end{cases}$		16.8		V
		$I_{PP} = \pm 16 \text{ A} \begin{cases} \text{IEC } 61000 - 4 - 2 \text{ Level 4 equivalent} \\ (\pm 8 \text{ kV Contact}, \pm 15 \text{ kV Air}) \end{cases}$		24.9		

1. ANSI/ESD STM5.5.1 – Electrostatic Discharge Sensitivity Testing using Transmission Line Pulse (TLP) Model. TLP conditions: $Z_0 = 50 \ \Omega$, $t_p = 100 \ ns$, $t_r = 4 \ ns$, averaging window; $t_1 = 30 \ ns$ to $t_2 = 60 \ ns$.

ESD7124

TYPICAL CHARACTERISTICS

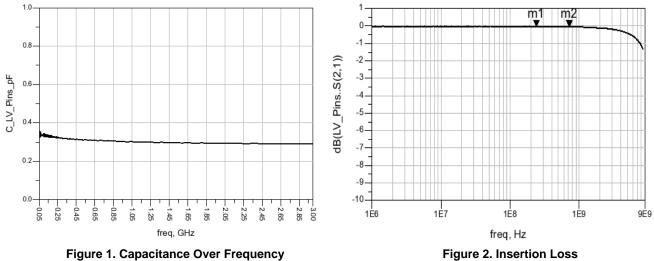
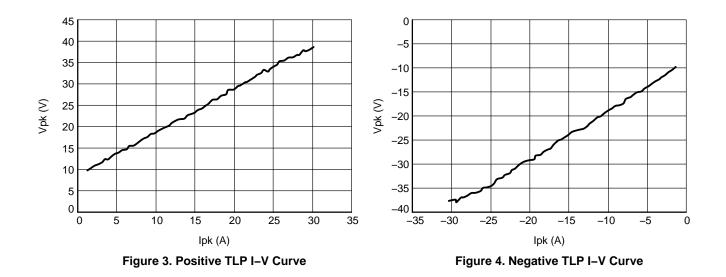


Figure 2. Insertion Loss

Interface	Data Rate (Mb/s)	Fundamental Frequency (MHz)	3 rd Harmonic Frequency (MHz)	ESD7124 Insertion Loss (dB)
USB 2.0	480	240 (m1)	720 (m2)	m1 = 0.031 m2 = 0.047



Transmission Line Pulse (TLP) Measurement

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 5. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 6 where an 8 kV IEC 61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP I–V curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels. For more information on TLP measurements and how to interpret them please refer to AND9007/D.

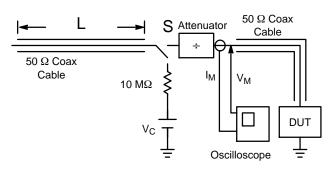


Figure 5. Simplified Schematic of a Typical TLP System

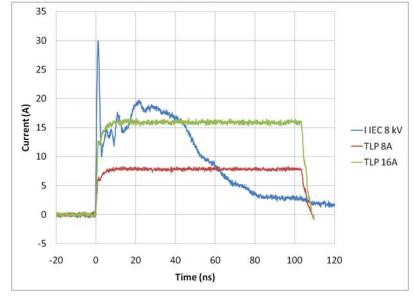
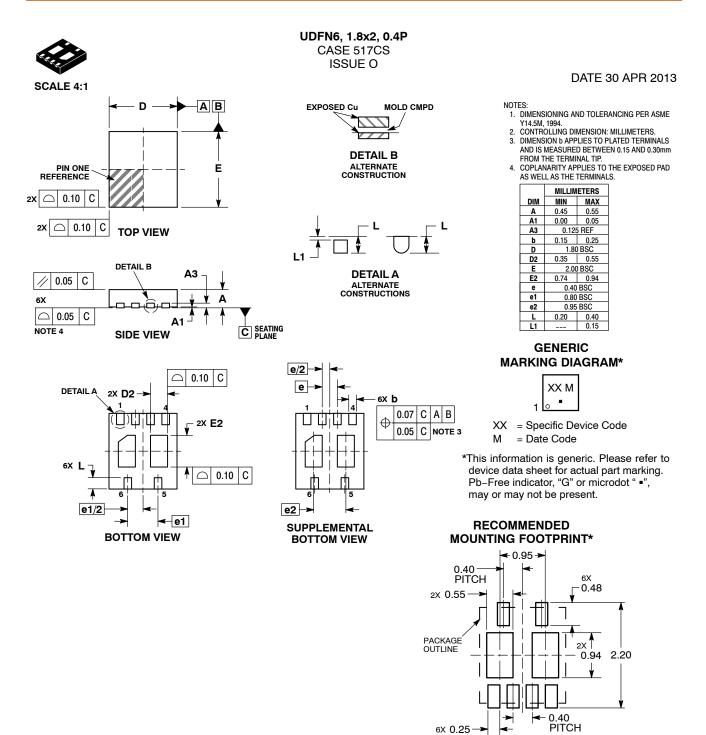


Figure 6. Comparison Between 8 kV IEC 61000-4-2 and 8 A and 16 A TLP Waveforms

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DIMENSIONS: MILLIMETERS *For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	UDFN6 1.8X2, 0.4P		PAGE 1 OF 1	

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